



General Description

The WST2028 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST2028 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

BVDSS	RDSON	ID
20V	50mΩ	2.1A

Applications

- High Frequency Point-of-Load Synchronous
 Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOT-323 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter Rating		Units
V_{DS}	Drain-Source Voltage 20		V
V_{GS}	Gate-Source Voltage	±8	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	2.1	А
I _D @T _C =70°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	1.1	Α
I _{DM}	Pulsed Drain Current ²	8.2	Α
P _D @T _A =25℃	Total Power Dissipation ³	0.35	W
T _{STG}	Storage Temperature Range	-55 to 150	$^{\circ}$
T_J	Operating Junction Temperature Range	-55 to 150	$^{\circ}$

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-ambient ¹		357	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		135	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.022		V/°C
	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =2A		50	60	mΩ
R _{DS(ON)}		V _{GS} =2.5V , I _D =1A		70	90	
V _{GS(th)}	Gate Threshold Voltage		0.5		1.2	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$-V_{GS}=V_{DS}$, $I_D=250uA$		-2.33		mV/℃
	Drain-Source Leakage Current	V _{DS} =16V , V _{GS} =0V , T _J =25℃			1	
I _{DSS}		V _{DS} =16V , V _{GS} =0V , T _J =55°C			5	· uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = \pm 12 V , V_{DS} =0 V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =2A		12		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		6.0		Ω
Qg	Total Gate Charge (4.5V)	V _{DS} =10V , V _{GS} =4.5V , I _D =2A		5.0		
Q _{gs}	Gate-Source Charge			0.8		nC
Q _{gd}	Gate-Drain Charge			1.7		
T _{d(on)}	Turn-On Delay Time	V_{DD} =10V , V_{GS} =4.5V , R_G =6 Ω I_D =1A		3.2		
Tr	Rise Time			12		ns
T _{d(off)}	Turn-Off Delay Time			26		
T _f	Fall Time			4		
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		300		
C _{oss}	Output Capacitance			57		pF
C _{rss}	Reverse Transfer Capacitance			47		1

Diode Characteristics

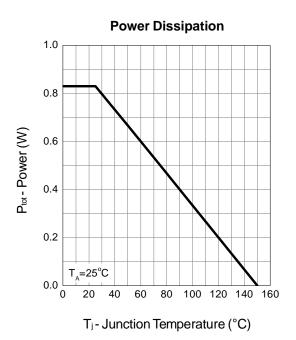
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}	V =V =0V Force Current			2.1	Α
I _{SM}	Pulsed Source Current ^{2,4}	$V_G=V_D=0V$, Force Current			8.0	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.3	V
t _{rr}	Reverse Recovery Time			10		nS
Qrr	Reverse Recovery Charge	IF=2A , dI/dt=100A/ μ s , T $_{J}$ =25 $^{\circ}$ C		3.2		nC

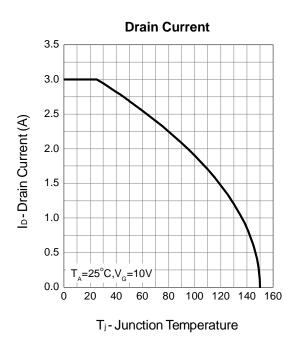
Note

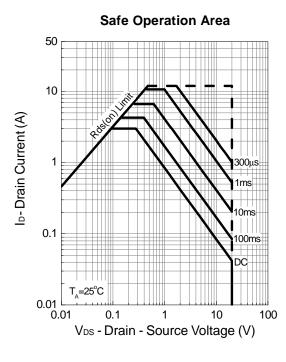
- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3.The power dissipation is limited by 150 $^{\circ}\mathrm{C}^{}$ junction temperature
- 4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

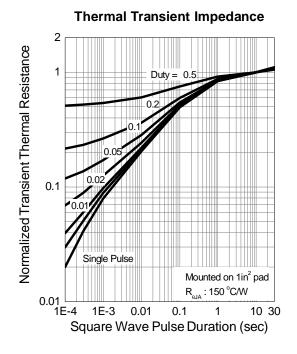


Typical Characteristics



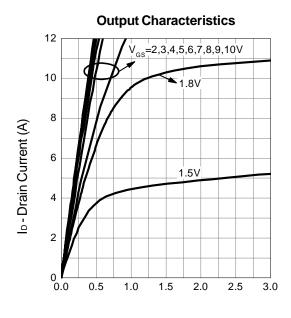




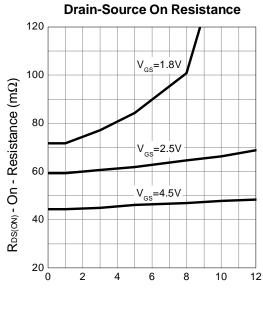




Typical Characteristics

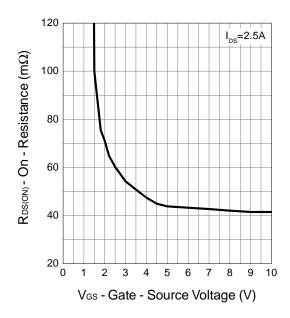


V_{DS}-Drain - Source Voltage (V)

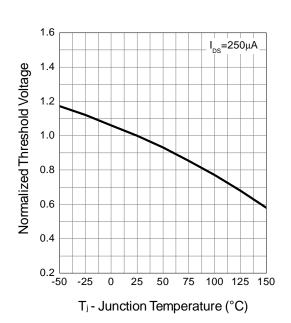


ID-Drain Current (A)

Gate-Source On Resistance

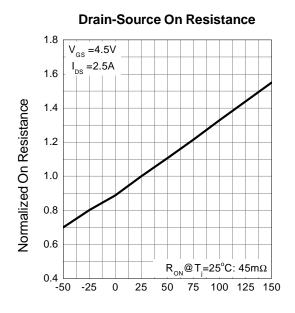


Gate Threshold Voltage

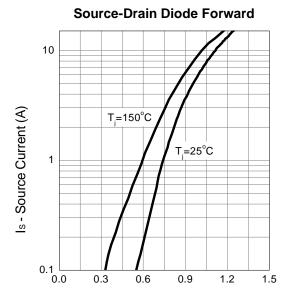




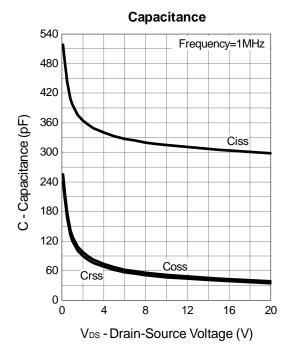
Typical Characteristics

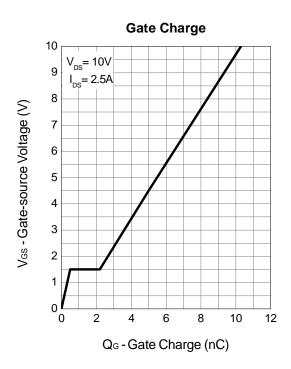


T_j- Junction Temperature (°C)



Vsp - Source - Drain Voltage (V)







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